


A/D 581-W

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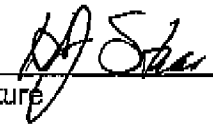
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4-14-04 08-11-2004

- Name and Address of receiving party(ies):
SHINKO ELECTRIC INDUSTRIES CO., LTD.
80 Oshimada-machi
Nagano-shi 381-2287
JAPAN
102812020
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 Other: _____
Execution Date(s): April 2, 2004
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- Application number(s) or patent number(s):
 This document is being filed together with a new application:
(a) The execution date(s) of the application is/are: April 2, 2004
(b) The title is: SEMICONDUCTOR COMPONENT
OR
 This document is being filed after filing of the application:
(a) Patent Application No(s) , filed April 14, 2004; or
(b) Patent No(s) , issued .
- Name and address of party to whom correspondence concerning document should be mailed:
STAAS & HALSEY LLP
Attention: H. J. Staas
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Our Docket: 300.1157
- Total number of applications and patents involved: 1
- Total fee (37 CFR 3.41)..... (\$ 40.00 per Patent or Application in Assignment)
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IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

(Insert
ASSIGNEE's
Name(s)
Address(es))

SHINKO ELECTRIC INDUSTRIES CO., LTD.

80, Oshimada-machi, Nagano-shi, Nagano 381-2287, Japan

(hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of
Invention)

SEMICONDUCTOR COMPONENT

relating to International Patent Application PCT/JP 02 / 10611 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was

(Insert date
of execution
of application,
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(a) executed on _____ ;
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Serial No. _____ / _____

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and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/hers/their signature(s).

(Signatures)

1	<u>Tsuyoshi Kobayashi</u> (SIGNATURE)	Tsuyoshi Kobayashi (TYPE NAME)	April 2, 2004 (DATE)
2	<u>Shigetatsu Muramatsu</u> (SIGNATURE)	Shigetatsu Muramatsu (TYPE NAME)	April 2, 2004 (DATE)
3	<u>Takuya Kazama</u> (SIGNATURE)	Takuya Kazama (TYPE NAME)	April 2, 2004 (DATE)
4	_____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)

PATENT